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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	dsPIC
Core Size	16-Bit
Speed	40 MIPS
Connectivity	I ² C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, Motor Control PWM, POR, PWM, WDT
Number of I/O	35
Program Memory Size	128KB (43K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 24x10/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 150°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33ev128gm004-h-pt

dsPIC33EVXXGM00X/10X FAMILY

Timers/Output Compare/Input Capture

- Nine General Purpose Timers:
 - Five 16-bit and up to two 32-bit timers/counters; Timer3 can provide ADC trigger
- Four Output Compare modules Configurable as Timers/Counters
- Four Input Capture modules

Communication Interfaces

- Two Enhanced Addressable Universal Asynchronous Receiver/Transmitter (UART) modules (6.25 Mbps):
 - With support for LIN/J2602 bus and IrDA®
 - High and low speed (SCI)
- Two SPI modules (15 Mbps):
 - 25 Mbps data rate without using PPS
- One I²C module (up to 1 Mbaud) with SMBus Support
- Two SENT J2716 (Single-Edge Nibble Transmission-Transmit/Receive) module for Automotive Applications
- One CAN module:
 - 32 buffers, 16 filters and three masks

Direct Memory Access (DMA)

- 4-Channel DMA with User-Selectable Priority Arbitration
- UART, Serial Peripheral Interface (SPI), ADC, Input Capture, Output Compare and Controller Area Network (CAN)

Input/Output

- GPIO Registers to Support Selectable Slew Rate I/Os
- Peripheral Pin Select (PPS) to allow Function Remap
- Sink/Source: 8 mA or 12 mA, Pin-Specific for Standard VOH/VOL
- Selectable Open-Drain, Pull-ups and Pull-Downs
- Change Notice Interrupts on All I/O Pins

Qualification and Class B Support

- AEC-Q100 REVG (Grade 1: -40°C to +125°C) Compliant
- AEC-Q100 REVG (Grade 0: -40°C to +150°C) Compliant
- Class B Safety Library, IEC 60730

Class B Fault Handling Support

- Backup FRC
- Windowed WDT uses LPRC
- Windowed Deadman Timer (DMT) uses System Clock (System Windowed Watchdog Timer)
- H/W Clock Monitor Circuit
- Oscillator Frequency Monitoring through CTMU (OSCI, SYSCLK, FRC, BFRC, LPRC)
- Dedicated PWM Fault Pin
- Lockable Clock Configuration

Debugger Development Support

- In-Circuit and In-Application Programming
- Three Complex and Five Simple Breakpoints
- Trace and Run-Time Watch

TABLE 4-17: PERIPHERAL INPUT REMAP REGISTER MAP

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RPINR0	06A0	INT1R<7:0>								—	—	—	—	—	—	—	—	0000
RPINR1	06A2	—	—	—	—	—	—	—	—	INT2R<7:0>								0000
RPINR3	06A6	—	—	—	—	—	—	—	—	T2CKR<7:0>								0000
RPINR7	06AE	IC2R7	IC2R6	IC2R5	IC2R4	IC2R3	IC2R2	IC2R1	IC2R0	IC1R7	IC1R6	IC1R5	IC1R4	IC1R3	IC1R2	IC1R1	IC1R0	0000
RPINR8	06B0	IC4R7	IC4R6	IC4R5	IC4R4	IC4R3	IC4R2	IC4R1	IC4R0	IC3R7	IC3R6	IC3R5	IC3R4	IC3R3	IC3R2	IC3R1	IC3R0	0000
RPINR11	06B6	—	—	—	—	—	—	—	—	OCFAR<7:0>								0000
RPINR12	06B8	FLT2R7	FLT2R6	FLT2R5	FLT2R4	FLT2R3	FLT2R2	FLT2R1	FLT2R0	FLT1R7	FLT1R6	FLT1R5	FLT1R4	FLT1R3	FLT1R2	FLT1R1	FLT1R0	0000
RPINR18	06C4	—	—	—	—	—	—	—	—	U1RXR<7:0>								0000
RPINR19	06C6	—	—	—	—	—	—	—	—	U2RXR<7:0>								0000
RPINR22	06CC	SCK2R7	SCK2R6	SCK2R5	SCK2R4	SCK2R3	SCK2R2	SCK2R1	SCK2R0	SDI2R7	SDI2R6	SDI2R5	SDI2R4	SDI2R3	SDI2R2	SDI2R1	SDI2R0	0000
RPINR23	06CE	—	—	—	—	—	—	—	—	SS2R<7:0>								0000
RPINR26	06D4	—	—	—	—	—	—	—	—	C1RXR<7:0> ⁽¹⁾								0000
RPINR37	06EA	SYNC1R<7:0>								—	—	—	—	—	—	—	—	0000
RPINR38	06EC	DTCMP1R<7:0>								—	—	—	—	—	—	—	—	0000
RPINR39	06EE	DTCMP3R7	DTCMP3R6	DTCMP3R5	DTCMP3R4	DTCMP3R3	DTCMP3R2	DTCMP3R1	DTCMP3R0	DTCMP2R7	DTCMP2R6	DTCMP2R5	DTCMP2R4	DTCMP2R3	DTCMP2R2	DTCMP2R1	DTCMP2R0	0000
RPINR44	06F8	SENT1R<7:0>								—	—	—	—	—	—	—	—	0000
RPINR45	06FA	—	—	—	—	—	—	—	—	SENT2R<7:0>								0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: This feature is available only on dsPIC33EVXXGM10X devices.

TABLE 4-18: DMT REGISTER MAP

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets	
DMTCON	0700	ON	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
DMTPRECLR	0704	STEP1<7:0>									—	—	—	—	—	—	—	—	0000
DMTCLR	0708	—	—	—	—	—	—	—	—	STEP2<7:0>								0000	
DMTSTAT	070C	—	—	—	—	—	—	—	—	BAD1	BAD2	DMTEVENT	—	—	—	—	WINOPN	0000	
DMTCNTL	0710	COUNTER<15:0>																	0000
DMTCNTH	0712	COUNTER<31:16>																	0000
DMTHOLDREG	0714	UPRCNT<15:0>																	0000
DMTPSCNTL	0718	PSCNT<15:0>																	0000
DMTPSCNTH	071A	PSCNT<31:16>																	0000
DMTPSINTVL	071C	PSINTV<15:0>																	0000
DMTPSINTVH	071E	PSINTV<31:16>																	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-39: PORTD REGISTER MAP FOR dsPIC33EVXXXGMX06 DEVICES

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISD	0E3C	—	—	—	—	—	—	—	TRISD8	—	TRISD<6:5>		—	—	—	—	—	0160
PORTD	0E3E	—	—	—	—	—	—	—	RD8	—	RD<6:5>		—	—	—	—	—	xxxx
LATD	0E40	—	—	—	—	—	—	—	LATD8	—	LATD<6:5>		—	—	—	—	—	xxxx
ODCD	0E42	—	—	—	—	—	—	—	ODCD8	—	ODCD<6:5>		—	—	—	—	—	0000
CNEND	0E44	—	—	—	—	—	—	—	CNIED8	—	CNIED<6:5>		—	—	—	—	—	0000
CNPUD	0E46	—	—	—	—	—	—	—	CNPUD8	—	CNPUD<6:5>		—	—	—	—	—	0000
CNPDD	0E48	—	—	—	—	—	—	—	CNPDD8	—	CNPDD<6:5>		—	—	—	—	—	0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-40: PORTE REGISTER MAP FOR dsPIC33EVXXXGMX06 DEVICES

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISE	0E50	TRISE<15:12>				—	—	—	—	—	—	—	—	—	—	—	—	F000
PORTE	0E52	RE<15:12>				—	—	—	—	—	—	—	—	—	—	—	—	xxxx
LATE	0E54	LATE<15:12>				—	—	—	—	—	—	—	—	—	—	—	—	xxxx
ODCE	0E56	ODCE<15:12>				—	—	—	—	—	—	—	—	—	—	—	—	0000
CNENE	0E58	CNIEE<15:12>				—	—	—	—	—	—	—	—	—	—	—	—	0000
CNPUE	0E5A	CNPUE<15:12>				—	—	—	—	—	—	—	—	—	—	—	—	0000
CNPDE	0E5C	CNPDE<15:12>				—	—	—	—	—	—	—	—	—	—	—	—	0000
ANSELE	0E5E	ANSE<15:12>				—	—	—	—	—	—	—	—	—	—	—	—	F000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

dsPIC33EVXXGM00X/10X FAMILY

4.3.1 PAGED MEMORY SCHEME

The dsPIC33EVXXGM00X/10X family architecture extends the available DS through a paging scheme, which allows the available DS to be accessed using MOV instructions in a linear fashion for pre- and post-modified Effective Addresses (EAs). The upper half of the Base Data Space address is used in conjunction with the Data Space Page registers, the 10-bit Data Space Read Page register (DSRPAG) or the 9-bit Data Space Write Page register (DSWPAG), to form an EDS address, or Program Space Visibility (PSV) address.

The Data Space Page registers are located in the SFR space. Construction of the EDS address is shown in Figure 4-9 and Figure 4-10. When DSRPAG<9> = 0 and the base address bit, EA<15> = 1, the DSRPAG<8:0> bits are concatenated onto EA<14:0> to form the 24-bit EDS read address. Similarly, when the base address bit, EA<15> = 1, the DSWPAG<8:0> bits are concatenated onto EA<14:0> to form the 24-bit EDS write address.

FIGURE 4-9: EXTENDED DATA SPACE (EDS) READ ADDRESS GENERATION

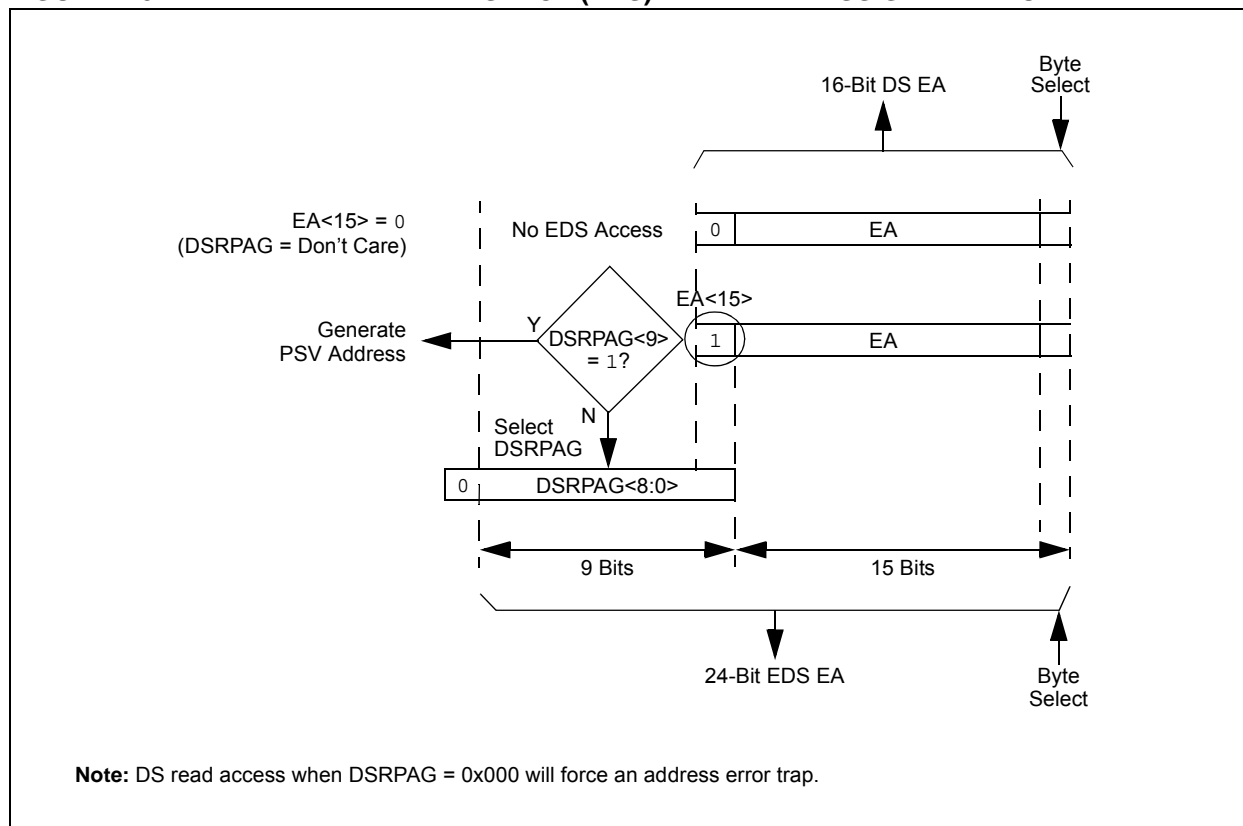


TABLE 4-45: FUNDAMENTAL ADDRESSING MODES SUPPORTED

Addressing Mode	Description
File Register Direct	The address of the file register is specified explicitly.
Register Direct	The contents of a register are accessed directly.
Register Indirect	The contents of Wn form the Effective Address (EA).
Register Indirect Post-Modified	The contents of Wn form the EA. Wn is post-modified (incremented or decremented) by a constant value.
Register Indirect Pre-Modified	Wn is pre-modified (incremented or decremented) by a signed constant value to form the EA.
Register Indirect with Register Offset (Register Indexed)	The sum of Wn and Wb forms the EA.
Register Indirect with Literal Offset	The sum of Wn and a literal forms the EA.

4.4.3 MOVE AND ACCUMULATOR INSTRUCTIONS

Move instructions and the DSP accumulator class of instructions provide a greater addressing flexibility than other instructions. In addition to the addressing modes supported by most MCU instructions, move and accumulator instructions also support Register Indirect with Register Offset Addressing mode, also referred to as Register Indexed mode.

Note: For the `MOV` instructions, the addressing mode specified in the instruction can differ for the source and destination EA. However, the 4-bit Wb (Register Offset) field is shared by both source and destination (but typically only used by one).

In summary, the following addressing modes are supported by move and accumulator instructions:

- Register Direct
- Register Indirect
- Register Indirect Post-Modified
- Register Indirect Pre-Modified
- Register Indirect with Register Offset (Indexed)
- Register Indirect with Literal Offset
- 8-Bit Literal
- 16-Bit Literal

Note: Not all instructions support all the addressing modes given above. Individual instructions may support different subsets of these addressing modes.

4.4.4 MAC INSTRUCTIONS

The dual source operand DSP instructions (`CLR`, `ED`, `EDAC`, `MAC`, `MPY`, `MPY.N`, `MOVSAC` and `MSC`), also referred to as MAC instructions, use a simplified set of addressing modes to allow the user application to effectively manipulate the Data Pointers through register indirect tables.

The Two-Source Operand Prefetch registers must be members of the set, {W8, W9, W10, W11}. For data reads, W8 and W9 are always directed to the X RAGU, and W10 and W11 are always directed to the Y AGU. The Effective Addresses generated (before and after modification) must, therefore, be valid addresses within X Data Space for W8 and W9, and Y Data Space for W10 and W11.

Note: Register Indirect with Register Offset Addressing mode is available only for W9 (in X Data Space) and W11 (in Y Data Space).

In summary, the following addressing modes are supported by the MAC class of instructions:

- Register Indirect
- Register Indirect Post-Modified by 2
- Register Indirect Post-Modified by 4
- Register Indirect Post-Modified by 6
- Register Indirect with Register Offset (Indexed)

4.4.5 OTHER INSTRUCTIONS

Besides the addressing modes outlined previously, some instructions use literal constants of various sizes. For example, `BRA` (Branch) instructions use 16-bit signed literals to specify the Branch destination directly, whereas the `DISI` instruction uses a 14-bit unsigned literal field. In some instructions, such as `ULNK`, the source of an operand or result is implied by the opcode itself. Certain operations, such as a `NOF`, do not have any operands.

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REGISTER 8-12: DMARQC: DMA REQUEST COLLISION STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	R-0	R-0	R-0	R-0
—	—	—	—	RQCOL3	RQCOL2	RQCOL1	RQCOL0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-4 **Unimplemented:** Read as '0'

bit 3 **RQCOL3:** Channel 3 Transfer Request Collision Flag bit

1 = User force and interrupt-based request collision is detected

0 = User force and interrupt-based request collision is not detected

bit 2 **RQCOL2:** Channel 2 Transfer Request Collision Flag bit

1 = User force and interrupt-based request collision is detected

0 = User force and interrupt-based request collision is not detected

bit 1 **RQCOL1:** Channel 1 Transfer Request Collision Flag bit

1 = User force and interrupt-based request collision is detected

0 = User force and interrupt-based request collision is not detected

bit 0 **RQCOL0:** Channel 0 Transfer Request Collision Flag bit

1 = User force and interrupt-based request collision is detected

0 = User force and interrupt-based request collision is not detected

11.6 High-Voltage Detect (HVD)

dsPIC33EVXXXGM00X/10X devices contain High-Voltage Detection (HVD) which monitors the VCAP voltage. The HVD is used to monitor the VCAP supply voltage to ensure that an external connection does not raise the value above a safe level (~2.4V). If high core voltage is detected, all I/Os are disabled and put in a tri-state condition. The device remains in this I/O tri-state condition as long as the high-voltage condition is present.

11.7 I/O Helpful Tips

1. In some cases, certain pins, as defined in Table 30-10 under "Injection Current", have internal protection diodes to VDD and VSS. The term, "Injection Current", is also referred to as "Clamp Current". On designated pins with sufficient external current-limiting precautions by the user, I/O pin input voltages are allowed to be greater or less than the data sheet absolute maximum ratings, with respect to the VSS and VDD supplies. Note that when the user application forward biases either of the high or low side internal input clamp diodes that the resulting current being injected into the device, that is clamped internally by the VDD and VSS power rails, may affect the ADC accuracy by four to six counts.
2. I/O pins that are shared with any analog input pin (i.e., ANx) are always analog pins by default after any Reset. Consequently, configuring a pin as an analog input pin automatically disables the digital input pin buffer and any attempt to read the digital input level by reading PORTx or LATx will always return a '0', regardless of the digital logic level on the pin. To use a pin as a digital I/O pin on a shared ANx pin, the user application needs to configure the Analog Pin Configuration registers in the I/O ports module (i.e., ANSELx) by setting the appropriate bit that corresponds to that I/O port pin to a '0'.

Note: Although it is not possible to use a digital input pin when its analog function is enabled, it is possible to use the digital I/O output function, TRISx = 0x0, while the analog function is also enabled. However, this is not recommended, particularly if the analog input is connected to an external analog voltage source, which would create signal contention between the analog signal and the output pin driver.

3. Most I/O pins have multiple functions. Referring to the device pin diagrams in this data sheet, the priorities of the functions allocated to any pins are indicated by reading the pin name, from left-to-right. The left most function name takes precedence over any function to its right in the naming convention; for example, AN16/T2CK/T7CK/RC1. This indicates that AN16 is the highest priority in this example and will supersede all other functions to its right in the list. Those other functions to its right, even if enabled, would not work as long as any other function to its left was enabled. This rule applies to all of the functions listed for a given pin.
4. Each pin has an internal weak pull-up resistor and pull-down resistor that can be configured using the CNPUx and CNPDx registers, respectively. These resistors eliminate the need for external resistors in certain applications. The internal pull-up is up to $\sim(VDD - 0.8)$, not VDD. This value is still above the minimum VIH of CMOS and TTL devices.
5. When driving LEDs directly, the I/O pin can source or sink more current than what is specified in the VOH/IOH and VOL/IOL DC characteristic specifications. The respective IOH and IOL current rating only applies to maintaining the corresponding output at or above the VOH, and at or below the VOL levels. However, for LEDs, unlike digital inputs of an externally connected device, they are not governed by the same minimum VIH/VIL levels. An I/O pin output can safely sink or source any current less than that listed in the absolute maximum rating section of this data sheet. For example:

$$VOH = 4.4V \text{ at } IOH = -8 \text{ mA and } VDD = 5V$$

The maximum output current sourced by any 8 mA I/O pin = 12 mA.

LED source current, <12 mA, is technically permitted. For more information, refer to the VOH/IOH specifications in **Section 30.0 "Electrical Characteristics"**.

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REGISTER 11-22: RPOR4: PERIPHERAL PIN SELECT OUTPUT REGISTER 4

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP43R5	RP43R4	RP43R3	RP43R2	RP43R1	RP43R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP42R5	RP42R4	RP42R3	RP42R2	RP42R1	RP42R0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **RP43R<5:0>:** Peripheral Output Function is Assigned to RP43 Output Pin bits
(see Table 11-3 for peripheral function numbers)

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **RP42R<5:0>:** Peripheral Output Function is Assigned to RP42 Output Pin bits
(see Table 11-3 for peripheral function numbers)

REGISTER 11-23: RPOR5: PERIPHERAL PIN SELECT OUTPUT REGISTER 5⁽¹⁾

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP49R5	RP49R4	RP49R3	RP49R2	RP49R1	RP49R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP48R5	RP48R4	RP48R3	RP48R2	RP48R1	RP48R0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **RP49R<5:0>:** Peripheral Output Function is Assigned to RP49 Output Pin bits
(see Table 11-3 for peripheral function numbers)

bit 7-6 **Unimplemented:** Read as '0'

bit 5-0 **RP48R<5:0>:** Peripheral Output Function is Assigned to RP48 Output Pin bits
(see Table 11-3 for peripheral function numbers)

Note 1: This register is present in dsPIC33EVXXXGM004/104/006/106 devices only.

dsPIC33EVXXXGM00X/10X FAMILY

12.1 Timer1 Control Register

REGISTER 12-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
TON ⁽¹⁾	—	TSIDL	—	—	—	—	—
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0
—	TGATE	TCKPS1	TCKPS0	—	TSYNC ⁽¹⁾	TCS ⁽¹⁾	—
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

- bit 15 **TON:** Timer1 On bit⁽¹⁾
1 = Starts 16-bit Timer1
0 = Stops 16-bit Timer1
- bit 14 **Unimplemented:** Read as '0'
- bit 13 **TSIDL:** Timer1 Stop in Idle Mode bit
1 = Discontinues module operation when the device enters Idle mode
0 = Continues module operation in Idle mode
- bit 12-7 **Unimplemented:** Read as '0'
- bit 6 **TGATE:** Timer1 Gated Time Accumulation Enable bit
When TCS = 1:
This bit is ignored.
When TCS = 0:
1 = Gated time accumulation is enabled
0 = Gated time accumulation is disabled
- bit 5-4 **TCKPS<1:0>:** Timer1 Input Clock Prescale Select bits
11 = 1:256
10 = 1:64
01 = 1:8
00 = 1:1
- bit 3 **Unimplemented:** Read as '0'
- bit 2 **TSYNC:** Timer1 External Clock Input Synchronization Select bit⁽¹⁾
When TCS = 1:
1 = External clock input is synchronized
0 = External clock input is not synchronized
When TCS = 0:
This bit is ignored.
- bit 1 **TCS:** Timer1 Clock Source Select bit⁽¹⁾
1 = External clock is from pin, T1CK (on the rising edge)
0 = Internal clock (Fp)
- bit 0 **Unimplemented:** Read as '0'

Note 1: When Timer1 is enabled in External Synchronous Counter mode (TCS = 1, TSYNC = 1, TON = 1), any attempts by user software to write to the TMR1 register are ignored.

dsPIC33EVXXXGM00X/10X FAMILY

REGISTER 14-4: DMTSTAT: DEADMAN TIMER STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R-0, HC	R-0, HC	R-0, HC	U-0	U-0	U-0	U-0	R-0
BAD1	BAD2	DMTEVENT	—	—	—	—	WINOPN
bit 7							bit 0

Legend:	HC = Hardware Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 15-8 **Unimplemented:** Read as '0'
- bit 7 **BAD1:** Deadman Timer Bad STEP1<7:0> Value Detect bit
 1 = Incorrect STEP1<7:0> value was detected
 0 = Incorrect STEP1<7:0> value was not detected
- bit 6 **BAD2:** Deadman Timer Bad STEP2<7:0> Value Detect bit
 1 = Incorrect STEP2<7:0> value was detected
 0 = Incorrect STEP2<7:0> value was not detected
- bit 5 **DMTEVENT:** Deadman Timer Event bit
 1 = Deadman Timer event was detected (counter expired, or bad STEP1<7:0> or STEP2<7:0> value was entered prior to counter increment)
 0 = Deadman Timer event was not detected
- bit 4-1 **Unimplemented:** Read as '0'
- bit 0 **WINOPN:** Deadman Timer Clear Window bit
 1 = Deadman Timer clear window is open
 0 = Deadman Timer clear window is not open

dsPIC33EVXXXGM00X/10X FAMILY

15.1 Input Capture Control Registers

REGISTER 15-1: ICxCON1: INPUT CAPTURE x CONTROL REGISTER 1

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0
—	—	ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0	—	—
bit 15						bit 8	

U-0	R/W-0	R/W-0	R-0, HC, HS	R-0, HC, HS	R/W-0	R/W-0	R/W-0
—	ICI1	ICI0	ICOV	ICBNE	ICM2	ICM1	ICM0
bit 7						bit 0	

Legend:	HC = Hardware Clearable bit	HS = Hardware Settable bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared
		x = Bit is unknown

- bit 15-14 **Unimplemented:** Read as '0'
- bit 13 **ICSIDL:** Input Capture x Stop in Idle Mode Control bit
1 = Input Capture x will halt in CPU Idle mode
0 = Input Capture x will continue to operate in CPU Idle mode
- bit 12-10 **ICTSEL<2:0>:** Input Capture x Timer Select bits
111 = Peripheral clock (FP) is the clock source of the ICx
110 = Reserved
101 = Reserved
100 = T1CLK is the clock source of the ICx (only the synchronous clock is supported)
011 = T5CLK is the clock source of the ICx
010 = T4CLK is the clock source of the ICx
001 = T2CLK is the clock source of the ICx
000 = T3CLK is the clock source of the ICx
- bit 9-7 **Unimplemented:** Read as '0'
- bit 6-5 **ICI<1:0>:** Number of Captures per Interrupt Select bits (this field is not used if ICM<2:0> = 001 or 111)
11 = Interrupt on every fourth capture event
10 = Interrupt on every third capture event
01 = Interrupt on every second capture event
00 = Interrupt on every capture event
- bit 4 **ICOV:** Input Capture x Overflow Status Flag bit (read-only)
1 = Input Capture x buffer overflow has occurred
0 = Input Capture x buffer overflow has not occurred
- bit 3 **ICBNE:** Input Capture x Buffer Not Empty Status bit (read-only)
1 = Input Capture x buffer is not empty, at least one more capture value can be read
0 = Input Capture x buffer is empty
- bit 2-0 **ICM<2:0>:** Input Capture x Mode Select bits
111 = Input Capture x functions as an interrupt pin only in CPU Sleep and Idle modes (rising edge detect only, all other control bits are not applicable)
110 = Unused (module is disabled)
101 = Capture mode, every 16th rising edge (Prescaler Capture mode)
100 = Capture mode, every 4th rising edge (Prescaler Capture mode)
011 = Capture mode, every rising edge (Simple Capture mode)
010 = Capture mode, every falling edge (Simple Capture mode)
001 = Capture mode, every edge, rising and falling (Edge Detect mode (ICI<1:0>) is not used in this mode)
000 = Input Capture x module is turned off

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REGISTER 19-3: I2CxSTAT: I2Cx STATUS REGISTER (CONTINUED)

bit 3	S: I2Cx Start bit Updated when Start, Reset or Stop is detected; cleared when the I ² C module is disabled, I2CEN = 0. 1 = Indicates that a Start (or Repeated Start) bit has been detected last 0 = Indicates that a Start bit was not detected last
bit 2	R_W: Read/Write Information bit (when operating as I ² C slave) 1 = Read: Indicates that the data transfer is output from the slave 0 = Write: Indicates that the data transfer is input to the slave
bit 1	RBF: Receive Buffer Full Status bit 1 = Receive is complete, the I2CxRCV bit is full 0 = Receive is not complete, the I2CxRCV bit is empty
bit 0	TBF: Transmit Buffer Full Status bit 1 = Transmit is in progress, I2CxTRN is full (8 bits of data) 0 = Transmit is complete, I2CxTRN is empty

REGISTER 19-4: I2CxMSK: I2Cx SLAVE MODE ADDRESS MASK REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
—	—	—	—	—	—	MSK<9:8>	
bit 15						bit 8	

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
MSK<7:0>							
bit 7						bit 0	

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared
		x = Bit is unknown

bit 15-10	Unimplemented: Read as '0'
bit 9-0	MSK<9:0>: I2Cx Mask for Address Bit x Select bits 1 = Enables masking for bit x of the incoming message address; bit match is not required in this position 0 = Disables masking for bit x; bit match is required in this position

REGISTER 20-2: SENTxSTAT: SENTx STATUS REGISTER (CONTINUED)

bit 0 **SYNCTXEN:** SENTx Synchronization Period Status/Transmit Enable bit⁽¹⁾

Module in Receive Mode (RCVEN = 1):
1 = A valid synchronization period was detected; the module is receiving nibble data
0 = No synchronization period has been detected; the module is not receiving nibble data

Module in Asynchronous Transmit Mode (RCVEN = 0, TXM = 0):
The bit always reads as '1' when the module is enabled, indicating the module transmits SENTx data frames continuously. The bit reads '0' when the module is disabled.

Module in Synchronous Transmit Mode (RCVEN = 0, TXM = 1):
1 = The module is transmitting a SENTx data frame
0 = The module is not transmitting a data frame, user software may set SYNCTXEN to start another data frame transmission

Note 1: In Receive mode (RCVEN = 1), the SYNCTXEN bit is read-only.

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REGISTER 21-1: UxMODE: UARTx MODE REGISTER (CONTINUED)

bit 5	ABAU : Auto-Baud Enable bit 1 = Baud rate measurement on the next character is enabled – requires reception of a Sync field (55h) before other data; cleared in hardware upon completion 0 = Baud rate measurement is disabled or has completed
bit 4	URXINV : UARTx Receive Polarity Inversion bit 1 = UxRX Idle state is '0' 0 = UxRX Idle state is '1'
bit 3	BRGH : High Baud Rate Enable bit 1 = BRG generates 4 clocks per bit period (4x baud clock, High-Speed mode) 0 = BRG generates 16 clocks per bit period (16x baud clock, Standard mode)
bit 2-1	PDSEL<1:0> : Parity and Data Selection bits 11 = 9-bit data, no parity 10 = 8-bit data, odd parity 01 = 8-bit data, even parity 00 = 8-bit data, no parity
bit 0	STSEL : Stop Bit Selection bit 1 = Two Stop bits 0 = One Stop bit

Note 1: Refer to “**Universal Asynchronous Receiver Transmitter (UART)**” (DS70000582) in the “*dsPIC33/PIC24 Family Reference Manual*” for information on enabling the UART module for receive or transmit operation.

2: This feature is only available for the 16x BRG mode (BRGH = 0).

3: This feature is only available on 44-pin and 64-pin devices.

4: This feature is only available on 64-pin devices.

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**TABLE 30-34: SPI2 SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 0, SMP = 0)
TIMING REQUIREMENTS**

AC CHARACTERISTICS			Standard Operating Conditions: 4.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param.	Symbol	Characteristic ⁽¹⁾	Min.	Typ. ⁽²⁾	Max.	Units	Conditions
SP70	FscP	Maximum SCK2 Input Frequency	—	—	15	MHz	See Note 3
SP72	TscF	SCK2 Input Fall Time	—	—	—	ns	See Parameter DO32 and Note 4
SP73	TscR	SCK2 Input Rise Time	—	—	—	ns	See Parameter DO31 and Note 4
SP30	TdoF	SDO2 Data Output Fall Time	—	—	—	ns	See Parameter DO32 and Note 4
SP31	TdoR	SDO2 Data Output Rise Time	—	—	—	ns	See Parameter DO31 and Note 4
SP35	Tsch2doV, TscL2doV	SDO2 Data Output Valid after SCK2 Edge	—	6	20	ns	
SP36	TdoV2scH, TdoV2scL	SDO2 Data Output Setup to First SCK2 Edge	30	—	—	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDI2 Data Input to SCK2 Edge	30	—	—	ns	
SP41	Tsch2diL, TscL2diL	Hold Time of SDI2 Data Input to SCK2 Edge	30	—	—	ns	
SP50	TssL2scH, TssL2scL	$\overline{SS2} \downarrow$ to SCK2 \uparrow or SCK2 \downarrow Input	120	—	—	ns	
SP51	TssH2doZ	$\overline{SS2} \uparrow$ to SDO2 Output High-Impedance	10	—	50	ns	See Note 4
SP52	Tsch2ssH, TscL2ssH	$\overline{SS2} \uparrow$ after SCK2 Edge	1.5 Tcy + 40	—	—	ns	See Note 4
SP60	TssL2doV	SDO2 Data Output Valid after $\overline{SS2}$ Edge	—	—	50	ns	

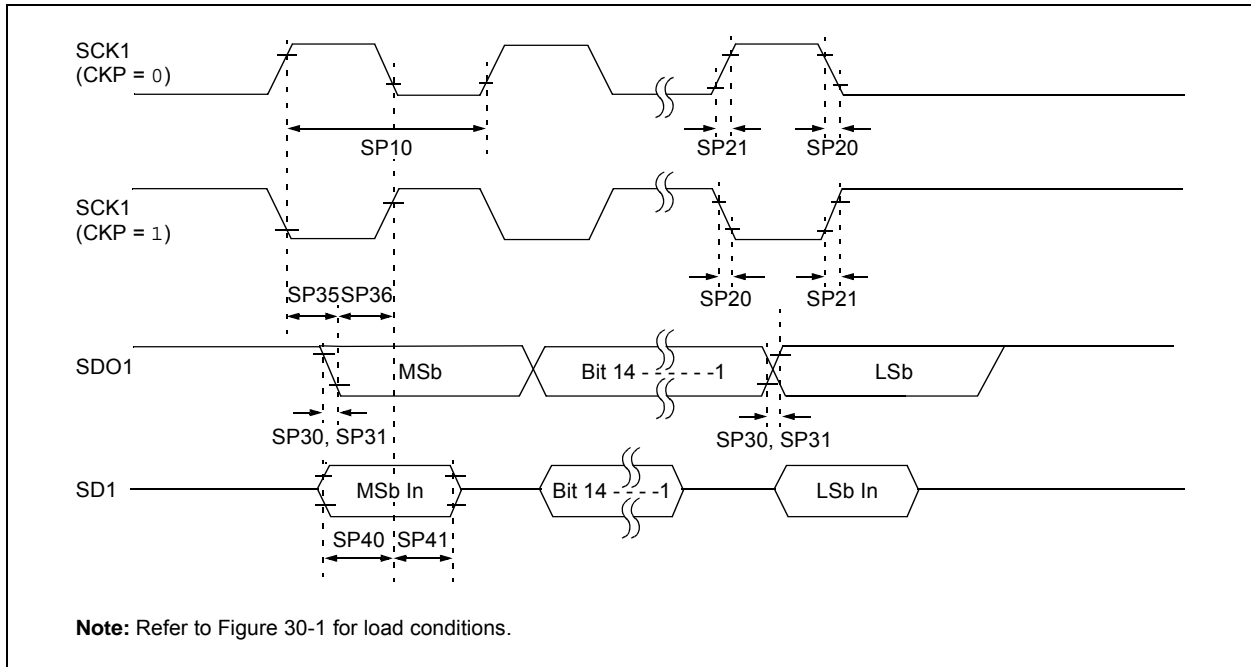
Note 1: These parameters are characterized but not tested in manufacturing.

2: Data in "Typ." column is at 5.0V, +25°C unless otherwise stated.

3: The minimum clock period for SCK2 is 66.7 ns. Therefore, the SCK2 clock generated by the master must not violate this specification.

4: Assumes 50 pF load on all SPI2 pins.

**FIGURE 30-23: SPI1 MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1)
TIMING CHARACTERISTICS**



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**TABLE 30-43: SPI1 SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 1, SMP = 0)
TIMING REQUIREMENTS**

AC CHARACTERISTICS			Standard Operating Conditions: 4.5V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param.	Symbol	Characteristic ⁽¹⁾	Min.	Typ. ⁽²⁾	Max.	Units	Conditions
SP70	FscP	Maximum SCK1 Input Frequency	—	—	25	MHz	See Note 3
SP72	TscF	SCK1 Input Fall Time	—	—	—	ns	See Parameter DO32 and Note 4
SP73	TscR	SCK1 Input Rise Time	—	—	—	ns	See Parameter DO31 and Note 4
SP30	TdoF	SDO1 Data Output Fall Time	—	—	—	ns	See Parameter DO32 and Note 4
SP31	TdoR	SDO1 Data Output Rise Time	—	—	—	ns	See Parameter DO31 and Note 4
SP35	Tsch2doV, TscL2doV	SDO1 Data Output Valid after SCK1 Edge	—	6	20	ns	
SP36	TdoV2scH, TdoV2scL	SDO1 Data Output Setup to First SCK1 Edge	20	—	—	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDI1 Data Input to SCK1 Edge	20	—	—	ns	
SP41	Tsch2diL, TscL2diL	Hold Time of SDI1 Data Input to SCK1 Edge	15	—	—	ns	
SP50	TssL2scH, TssL2scL	$\overline{SS1} \downarrow$ to SCK1 \uparrow or SCK1 \downarrow Input	120	—	—	ns	
SP51	TssH2doZ	$\overline{SS1} \uparrow$ to SDO1 Output High-Impedance	10	—	50	ns	See Note 4
SP52	Tsch2ssH, TscL2ssH	$\overline{SS1} \uparrow$ after SCK1 Edge	1.5 TCY + 40	—	—	ns	See Note 4
SP60	TssL2doV	SDO1 Data Output Valid after $\overline{SS1}$ Edge	—	—	50	ns	

Note 1: These parameters are characterized but not tested in manufacturing.

2: Data in “Typ.” column is at 5.0V, +25°C unless otherwise stated.

3: The minimum clock period for SCK1 is 40 ns. Therefore, the SCK1 clock generated by the master must not violate this specification.

4: Assumes 50 pF load on all SPI1 pins.

33.3 IDOZE

FIGURE 33-9: TYPICAL IDOZE vs. VDD (DOZE 1:2, 70 MIPS)

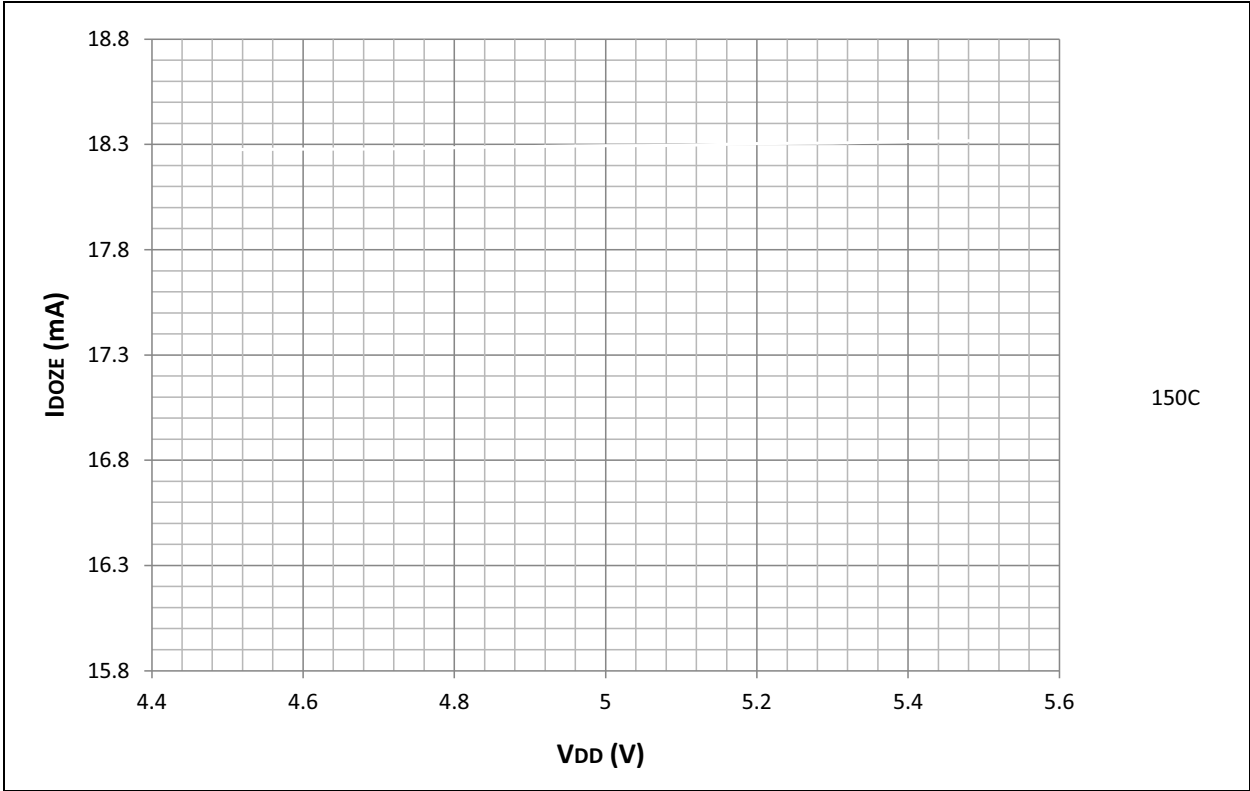
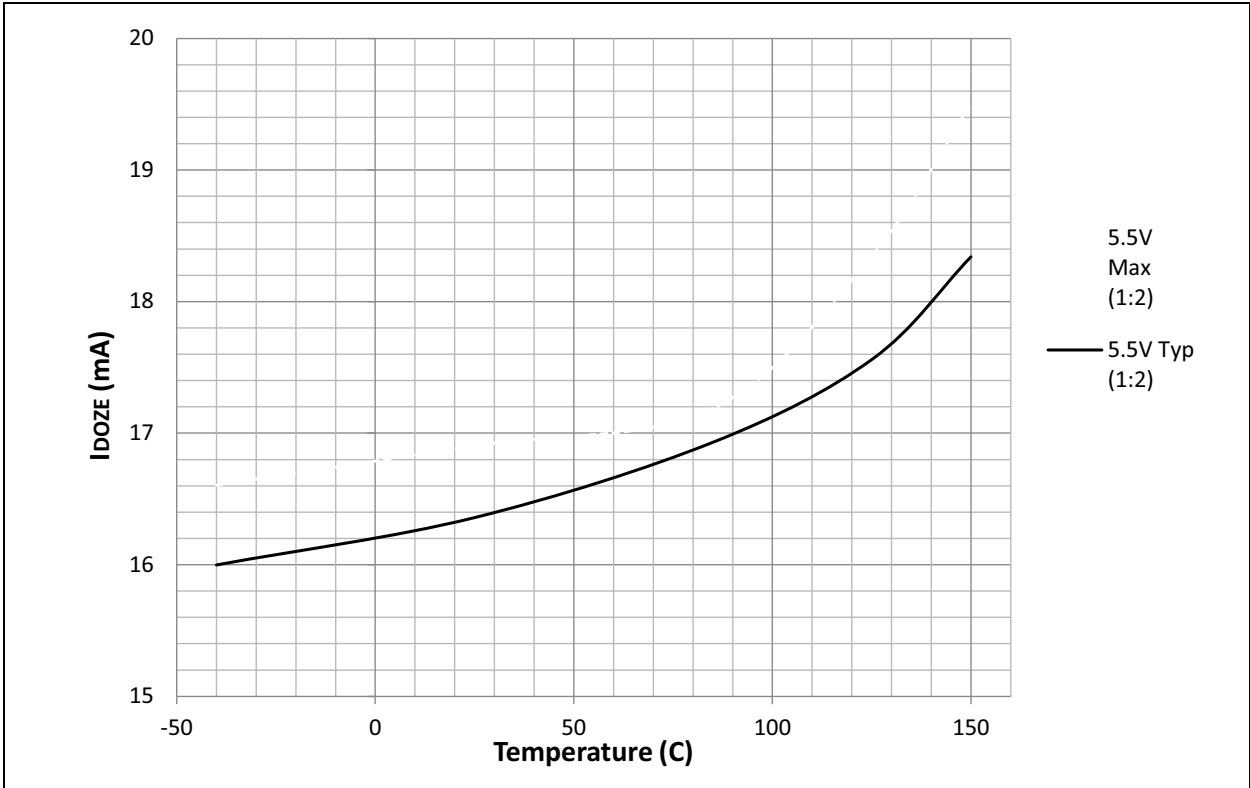


FIGURE 33-10: TYPICAL/MAXIMUM IDOZE vs. TEMPERATURE (DOZE 1:2, 70 MIPS)



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PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

<div><div><div>dsPIC 33 EV XXX GM0 0X T PT - XXX</div><div><div>Microchip Trademark</div><div>Architecture</div><div>Core Family</div><div>Program Memory Size (Kbytes)</div><div>Product Group</div><div>Pin Count</div><div>Tape and Reel Flag (if applicable)</div><div>Package</div><div>Pattern</div></div></div></div>		<div><div>Example:</div><div>dsPIC33EV256GM006-I/PT: dsPIC33, Enhanced Voltage, 256-Kbyte Program Memory, 64-Pin, Industrial Temperature, TQFP Package.</div></div>
<div><div>Architecture:</div><div>33 = 16-Bit Digital Signal Controller</div></div> <div><div>Family:</div><div>EV = Enhanced Voltage</div></div> <div><div>Product Group:</div><div>GM = General Purpose plus Motor Control Family</div></div> <div><div>Pin Count:</div><div>02 = 28-Pin</div><div>04 = 44-Pin</div><div>06 = 64-Pin</div></div> <div><div>Temperature Range</div><div>I = -40°C to +85°C (Industrial)</div><div>E = -40°C to +125°C (Extended)</div><div>H = -40°C to +150°C (High)</div></div> <div><div>Package:</div><div>MM = Plastic Quad Flat, No Lead Package – (28-pin) 6x6x0.9 mm body (QFN-S)</div><div>SO = Plastic Small Outline – (28-pin) 7.50 mm body (SOIC)</div><div>SS = Plastic Shrink Small Outline – (28-pin) 5.30 mm body (SSOP)</div><div>SP = Skinny Plastic Dual In-Line – (28-pin) 300 mil body (SPDIP)</div><div>ML = Plastic Quad Flat, No Lead Package – (44-pin) 8x8 mm body (QFN)</div><div>MR = Plastic Quad Flat, No Lead Package – (64-pin) 9x9x0.9 mm body (QFN)</div><div>PT = Plastic Thin Quad Flatpack – (44-pin) 10x10x1 mm body (TQFP)</div><div>PT = Plastic Thin Quad Flatpack – (64-pin) 10x10x1 mm body (TQFP)</div></div>		